



P-Channel 20-V(D-S) MOSFET SOT-23

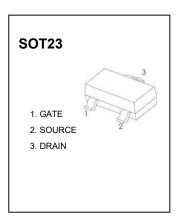
FEATURE

TrenchFET Power MOSFET

APPLICATIONS

x Load Switch for Portable Devices

DC/DC Converter



MARKING: A1SHB



Maximum ratings (Ta=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit	
Drain-Source Voltage	V _{DS}	-20	V	
Gate-Source Voltage	V _{GS}	±8	ď	
Continuous Drain Current	ID	-2.8		
Pulsed Drain Current	I _{DM}	-10	A	
Continuous Source-Drain Diode Current	Is	-0.72		
Maximum Power Dissipation	PD	0.35	W	
Thermal Resistance from Junction to Ambient(t ≤5s)	$R_{\theta JA}$	357	°C/W	
Junction Temperature	TJ	150		
Storage Temperature	T _{stg}	-55 ~+150	_ ი	





Electrical characteristics (Ta=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units	
Static			•	•			
Drain-source breakdown voltage	V(BR)DSS	V _G S = 0V, I _D =-250µA	-20				
Gate-source threshold voltage	VGS(th)	V _{DS} =V _{GS} , I _D =-250μA			-1	V	
Gate-source leakage	I _{GSS}	V _{DS} =0V, V _{GS} =±8V			±100	nA	
Zero gate voltage drain current	I _{DSS}	V _{DS} =-20V, V _{GS} =0V			-1	μΑ	
Drain-source on-state resistance ^a	RDS(on)	V _{GS} =-4.5V, I _D =-2.8A		0.090	0.112		
		V _{GS} =-2.5V, I _D =-2.0A		0.110	0.142	Ω	
Forward transconductance ^a	g _{fs}	V _{DS} =-5V, I _D =-2.8A		6.5		S	
Dynamic ^b					•	•	
Input capacitance	C _{iss}	V _{DS} =-10V,V _{GS} =0V,f =1MHz		405		pF	
Output capacitance	Coss			75			
Reverse transfer capacitance	C _{rss}			55			
Total gate charge	0	V _{DS} =-10V,V _{GS} =-4.5V,I _D =-3A		5.5	10	nC	
	Qg	V _{DS} =-10V,V _{GS} =-2.5V,I _D =-3A		3.3	6		
Gate-source charge	Q _{gs}			0.7			
Gate-drain charge	Q_{gd}			1.3			
Gate resistance	R_g	f=1MHz		6.0		Ω	
Turn-on delay time	td(on)	V _{DD} =-10V, R _L =10Ω, I _D =-1A,		11	20		
Rise time	tr			35	60	ns	
Turn-off delay time	td(off)			30	50		
Fall time	t f	V_{GEN} =-4.5V,Rg=1 Ω		10	20		
Drain-source body diode characteristics							
Continuous source-drain diode current	Is	T _C =25°C			-1.3	А	
Pulse diode forward current ^a	I _{SM}				-10		
Body diode voltage	V_{SD}	I _S =-0.7A		-0.8	-1.2	V	

Notes:

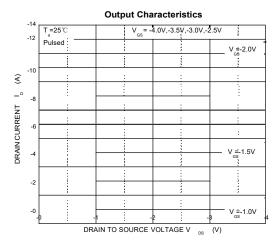
a.Pulse Test : Pulse Width < 300µs, Duty Cycle ≤2%.

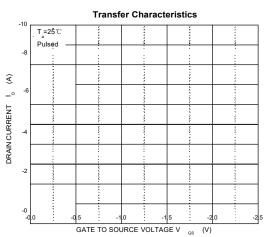
b.Guaranteed by design, not subject to production testing.

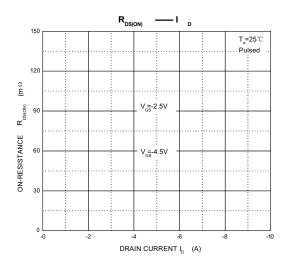


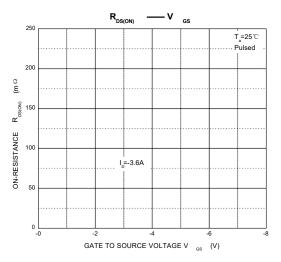


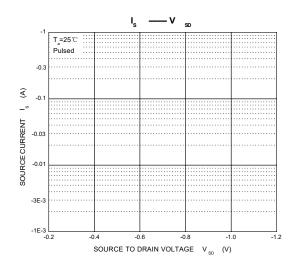
Typical Characteristics











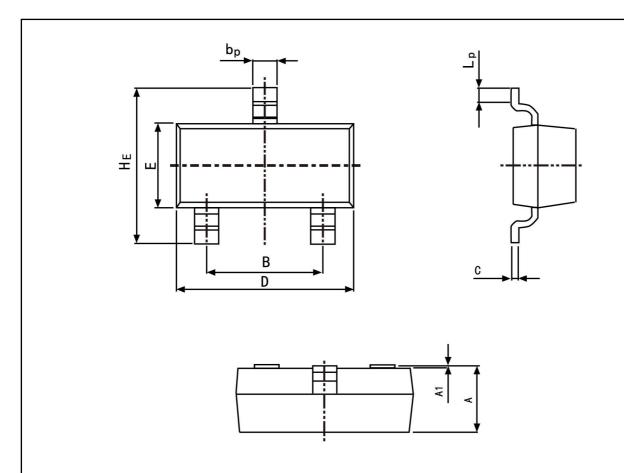




PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT-23



Symbol	Dimension in Millimeters			
Symbol	Min	Max		
А	0.95	1.40		
В	1.78	2.04		
bp	0.35	0.50		
С	0.08	0.19		
D	2.70	3.10		
E	1.20	1.65		
HE	2.20	3.00		
A1	0.100	0.013		
Lp	0.20	0.50		





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